Power MOSFET 20 Amps, 30 Volts, N-Channel DPAK

This logic level vertical power MOSFET is a general purpose part that provides the "best of design" available today in a low cost power package. Avalanche energy issues make this part an ideal design in. The drain—to—source diode has a ideal fast but soft recovery.

Features

- Pb-Free Packages are Available
- Ultra-Low R_{DS(on)}, Single Base, Advanced Technology
- SPICE Parameters Available
- Diode is Characterized for use in Bridge Circuits
- I_{DSS} and V_{DS(on)} Specified at Elevated Temperatures
- High Avalanche Energy Specified
- ESD JEDAC rated HBM Class 1, MM Class A, CDM Class 0

Typical Applications

- Power Supplies
- Inductive Loads
- PWM Motor Controls
- Replaces MTD20N03L in many Applications

MAXIMUM RATINGS (T_C = 25°C unless otherwise noted)

Rating	Symbol	Value	Unit
Drain-to-Source Voltage	V_{DSS}	30	Vdc
Drain-to-Gate Voltage ($R_{GS} = 1.0 \text{ M}\Omega$)	V_{DGR}	30	Vdc
Gate-to-Source Voltage - Continuous - Non-Repetitive (t _p ≤10 ms)	V _{GS} V _{GS}	±20 ±24	Vdc
Drain Current - Continuous @ T _A = 25°C - Continuous @ T _A = 100°C - Single Pulse (t _p ≤10 μs)	I _D I _D I _{DM}	20 16 60	Adc Apk
Total Power Dissipation @ T _A = 25°C Derate above 25°C Total Power Dissipation @ T _C = 25°C (Note 1)	P _D	74 0.6 1.75	W W/°C W
Operating and Storage Temperature Range	T _J , T _{stg}	-55 to 150	°C
Single Pulse Drain–to–Source Avalanche Energy – Starting $T_J = 25^{\circ}\text{C}$ ($V_{DD} = 30 \text{ Vdc}, V_{GS} = 5 \text{ Vdc}, L = 1.0 \text{ mH}, I_{L(pk)} = 24 \text{ A}, V_{DS} = 34 \text{ Vdc})$	E _{AS}	288	mJ
Thermal Resistance – Junction-to-Case – Junction-to-Ambient – Junction-to-Ambient (Note 1)	$egin{array}{c} R_{ heta JC} \ R_{ heta JA} \ R_{ heta JA} \end{array}$	1.67 100 71.4	°C/W
Maximum Lead Temperature for Soldering Purposes, 1/8" from case for 10 seconds	T _L	260	°C

Maximum ratings are those values beyond which device damage can occur. Maximum ratings applied to the device are individual stress limit values (not normal operating conditions) and are not valid simultaneously. If these limits are exceeded, device functional operation is not implied, damage may occur and reliability may be affected.

 When surface mounted to an FR4 board using the minimum recommended pad size and repetitive rating; pulse width limited by maximum junction temperature.

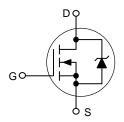


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20 A, 30 V, $R_{DS(on)}$ = 27 m Ω

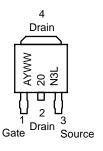
N-Channel



MARKING DIAGRAMS

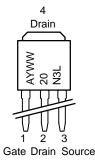


DPAK CASE 369C STYLE 2





DPAK-3 CASE 369D STYLE 2



20N3L = Device Code
A = Assembly Location
Y = Year

Y = Year WW = Work Week

ORDERING INFORMATION

See detailed ordering and shipping information in the package dimensions section on page 2 of this data sheet.

ELECTRICAL CHARACTERISTICS (T_C = 25°C unless otherwise noted)

Characteristic			Min	Тур	Max	Unit
OFF CHARACTERISTICS						
Drain-to-Source Breakdown Voltage (Note 2) (V _{GS} = 0 Vdc, I _D = 250 µAdc) Temperature Coefficient (Positive)			30 -	- 43	_ _	Vdc mV/°C
Zero Gate Voltage Drain Current (V _{DS} = 30 Vdc, V _{GS} = 0 Vdc) (V _{DS} = 30 Vdc, V _{GS} = 0 Vdc, T _J =150°C)			- -	- -	10 100	μAdc
Gate-Body Leakage Current (V _{GS} =		I _{GSS}	-	-	±100	nAdc
ON CHARACTERISTICS (Note 2)						
Gate Threshold Voltage (Note 2) (V _{DS} = V _{GS} , I _D = 250 µAdc) Threshold Temperature Coefficient (Negative)			1.0	1.6 5.0	2.0	Vdc mV/°C
Static Drain-to-Source On-Resistance (Note 2) ($V_{GS} = 4.0 \text{ Vdc}$, $I_D = 10 \text{ Adc}$) ($V_{GS} = 5.0 \text{ Vdc}$, $I_D = 10 \text{ Adc}$)			_ _	28 23	31 27	mΩ
Static Drain-to-Source On-Voltage (Note 2) $ (V_{GS} = 5.0 \text{ Vdc}, I_D = 20 \text{ Adc}) $ $ (V_{GS} = 5.0 \text{ Vdc}, I_D = 10 \text{ Adc}, T_J = 150^{\circ}\text{C}) $			- -	0.48 0.40	0.54 -	Vdc
Forward Transconductance (Note 2)	$(V_{DS} = 5.0 \text{ Vdc}, I_{D} = 10 \text{ Adc})$	g _{FS}	_	21	_	mhos
DYNAMIC CHARACTERISTICS						
Input Capacitance	$(V_{DS} = 25 \text{ Vdc}, V_{GS} = 0 \text{ Vdc},$	C _{iss}	-	1005	1260	pF
Output Capacitance	f = 1.0 MHz	C _{oss}	-	271	420	
Transfer Capacitance		C _{rss}	_	87	112	
SWITCHING CHARACTERISTICS (No	ote 3)		_			_
Turn-On Delay Time	(V _{DD} = 20 Vdc, I _D = 20 Adc,	t _{d(on)}	-	17	25	ns
Rise Time	$V_{GS} = 5.0 \text{ Vdc},$	t _r		137	160	
Turn-Off Delay Time	$R_G = 9.1 \Omega$) (Note 2)	t _{d(off)}	-	38 31	45	ŀ
Fall Time		t _f Q _T		13.8	40 18.9	nC
Gate Charge	$(V_{DS} = 48 \text{ Vdc}, I_{D} = 15 \text{ Adc},$	Q ₁	-	2.8	-	110
	V _{GS} = 10 Vdc) (Note 2)	Q ₂	_	6.6	_	1
SOURCE-DRAIN DIODE CHARACTE	RISTICS	~2	<u> </u>	0.0	1	1
Forward On–Voltage	(I _S = 20 Adc, V _{GS} = 0 Vdc) (Note 2) (I _S = 20 Adc, V _{GS} = 0 Vdc, T _J = 125°C)	V_{SD}	_ _	1.0 0.9	1.15 –	Vdc
Reverse Recovery Time		t _{rr}	_	23	_	ns
j	$(I_S = 15 \text{ Adc}, V_{GS} = 0 \text{ Vdc},$	t _a	_	13	_	1
	$dI_{S}/dt = 100 \text{ A/}\mu\text{s}) \text{ (Note 2)}$	t _b	-	10	_	1
Reverse Recovery Stored Charge	1	Q _{RR}	-	0.017	-	μC

ORDERING INFORMATION

Device	Package	Shipping [†]
NTD20N03L27	DPAK	75 Units/Rail
NTD20N03L27G	DPAK (Pb-Free)	75 Units/Rail
NTD20N03L27-1	DPAK-3	75 Units/Rail
NTD20N03L27–1G	DPAK (Pb-Free)	75 Units/Rail
NTD20N03L27T4	DPAK	2500 Tape & Reel
NTD20N03L27T4G	DPAK (Pb-Free)	2500 Tape & Reel

[†]For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

Pulse Test: Pulse Width ≤ 300 μs, Duty Cycle ≤ 2%.
 Switching characteristics are independent of operating junction temperature.

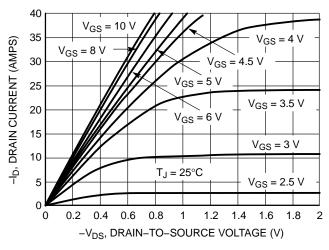


Figure 1. On-Region Characteristics

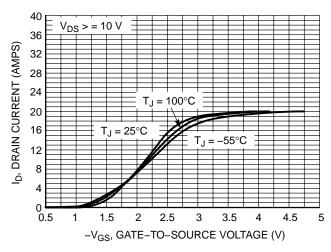


Figure 2. Transfer Characteristics

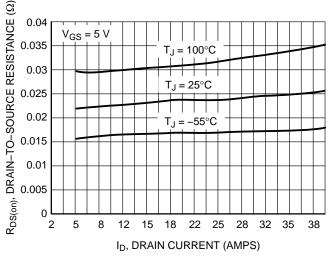


Figure 3. On–Resistance vs. Drain Current and Temperature

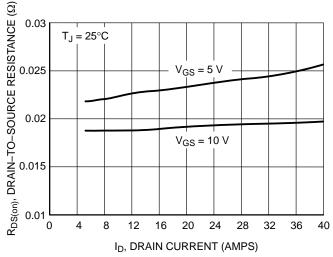


Figure 4. On-Resistance vs. Drain Current and Gate Voltage

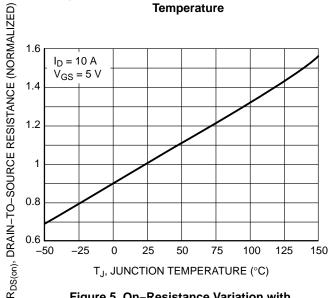


Figure 5. On–Resistance Variation with Temperature

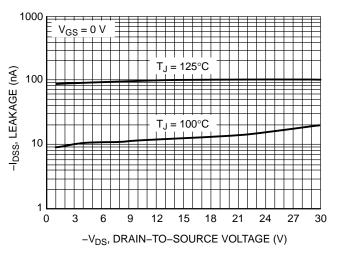


Figure 6. Drain-to-Source Leakage Current vs. Voltage

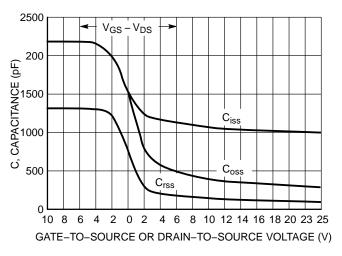


Figure 7. Capacitance Variation

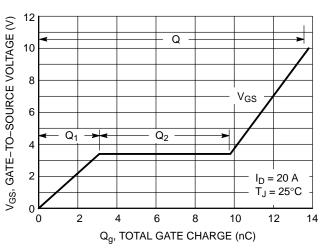


Figure 8. Gate-to-Source and Drain-to-Source Voltage vs. Total Charge

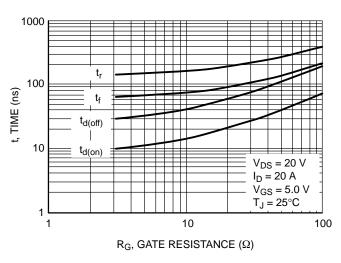


Figure 9. Resistive Switching Time Variation vs. Gate Resistance

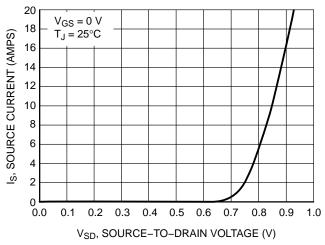


Figure 10. Diode Forward Voltage vs. Current

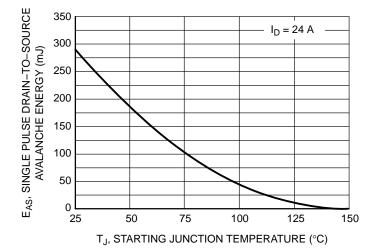
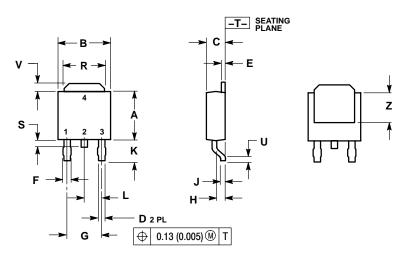


Figure 11. Maximum Avalanche Energy vs. Starting Junction Temperature

PACKAGE DIMENSIONS

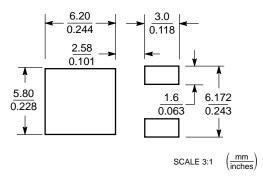
DPAK CASE 369C-01 **ISSUE O**



	INCHES		MILLIMETERS		
DIM	MIN	MAX	MIN	MAX	
Α	0.235	0.245	5.97	6.22	
В	0.250	0.265	6.35	6.73	
С	0.086	0.094	2.19	2.38	
D	0.027	0.035	0.69	0.88	
E	0.018	0.023	0.46	0.58	
F	0.037	0.045	0.94	1.14	
G	0.180 BSC		4.58 BSC		
Н	0.034	0.040	0.87	1.01	
J	0.018	0.023	0.46	0.58	
K	0.102	0.114	2.60	2.89	
L	0.090 BSC		2.29 BSC		
R	0.180	0.215	4.57	5.45	
S	0.025	0.040	0.63	1.01	
U	0.020		0.51		
٧	0.035	0.050	0.89	1.27	
Z	0.155		3.93		

STYLE 2: PIN 1. GATE 2. DRAIN 3. SOURCE 4. DRAIN

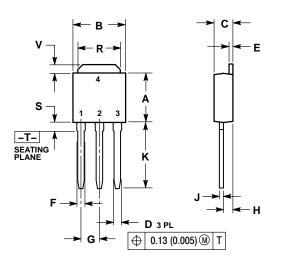
SOLDERING FOOTPRINT*

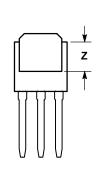


^{*}For additional information on our Pb–Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

PACKAGE DIMENSIONS

DPAK-3 CASE 369D-01 ISSUE B





- NOTES:
 1. DIMENSIONING AND TOLERANCING PER
- ANSI Y14.5M, 1982.
 2. CONTROLLING DIMENSION: INCH.

	INCHES		MILLIMETERS		
DIM	MIN	MAX	MIN	MAX	
Α	0.235	0.245	5.97	6.35	
В	0.250	0.265	6.35	6.73	
С	0.086	0.094	2.19	2.38	
D	0.027	0.035	0.69	0.88	
Е	0.018	0.023	0.46	0.58	
F	0.037	0.045	0.94	1.14	
G	0.090 BSC		2.29 BSC		
Н	0.034	0.040	0.87	1.01	
J	0.018	0.023	0.46	0.58	
K	0.350	0.380	8.89	9.65	
R	0.180	0.215	4.45	5.45	
S	0.025	0.040	0.63	1.01	
٧	0.035	0.050	0.89	1.27	
Z	0.155		3.93		

STYLE 2: PIN 1. GATE

- 2. DRAIN
- 3 SOURCE
- DRAIN

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N. American Technical Support: 800-282-9855 Toll Free

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